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## **DETAILED ACTION**

## **EXAMINER'S AMENDMENT**

1. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with Samuel Borodach on 10/28/04.

The application has been amended as follows:

In claim 1, lines 12,13, "arranged under a pad portion" should be changed to – arranged directly under a pad portion --.

In claim 1, lines 14,15, "formed under a pad portion" should be changed to – formed directly under a pad portion --.

In claim 34, lines 7,8, "arranged under a pad portion" should be changed to – arranged directly under a pad portion --.

In claim 34, line 10, "formed under a pad portion" should be changed to – formed directly under a pad portion --.

## Reasons for Allowance

2. The following is an examiner's statement of reasons for allowance:

Claims 21-23,28,31-39 are allowable over the reference of record because none of these references disclose or can be combined to yield the claimed invention such as the upper layer wiring and the lower layer wiring are arranged directly under a pad portion and in areas other than under the pad portion wherein no hole connecting the upper layer wiring and the lower layer wiring is formed directly under the pad portion as recited in claims 21,34, a low concentration region of the same conductivity type as the source/drain region formed under the gate electrode so as to connected to the source/drain region and to contact the semiconductor region as recited in claim 22.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled ""Comments on Statement of Reasons for Allowance.

3. Any inquiry concerning this communication or earlier communication from the examiner should be directed to Tan Tran whose telephone number is (571) 272-1923. The examiner can normally be reached on M-F 8:30AM-5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan Flynn can be reached on (571) 272-1915. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 872-9306 for regular communications and (703) 872-9306 for after final communications.

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Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 305-3900.

TT

Oct 2004